

### **Technical Data Sheet**

#### MODEL NO: S1923ANB4

0603 with lens Package 1.6\*0.8mm Chip SMD

Features :

•Package in 8mm tape on 7" diameter reel

•Compatible with automatic placement equipment

•Compatible with reflow solder process

Applications:

Indicators

•Automotive : backlighting in dashboard and switch

•Backlight for LCD

Dice material	Emitted color	Lens Color
InGaN	Blue	Water Clear

### Electrical/Optical Characteristics(Ta=25°C)

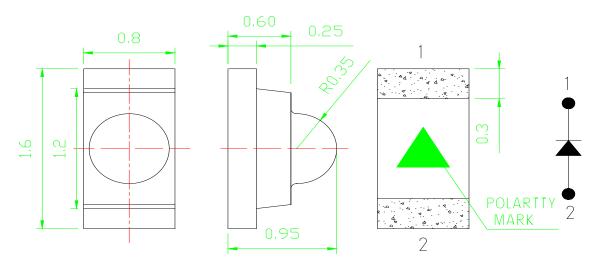
Parameter	Test	Symbol	Value			Unit
	Condition		Min	Тур	Мах	Unit
Dominant wavelength	IF=20mA	λD		465	472	nm
Forward voltage	IF=20mA	VF	2.9		3.4	V
Luminous intensity	IF=20mA	lv	150	450		mcd
Viewing angle at 50% Iv	IF=10mA	2 <i>0</i> 1/2		35		Deg
Reverse current	Vr=5V	lr			10	μA

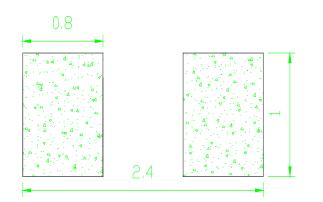
#### Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Value	Unit
Power dissipation	Pd	50	mW
Forward current	lf	20	mA
Reverse voltage	VR	5	V
Operating temperature range	Тор	-40 ~+80	°C
Storage temperature range	Tstg	-40 ~+85	°C
Peak pulsing current (1/8 duty f=1kHz)	FP	140	mA



### PACKAGING DIMENSIONS (mm):







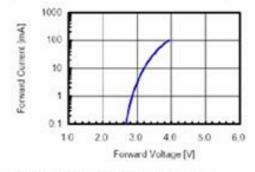


Fig 1. Forward Current vs. Forward Voltage



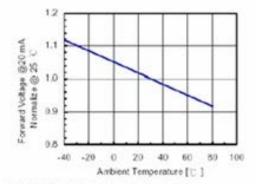


Fig 5.Relative Intensity vs. Wavelength

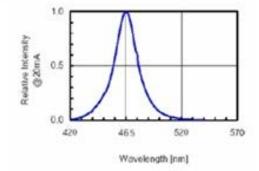
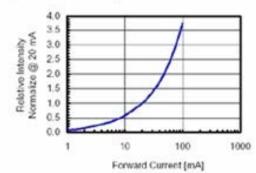
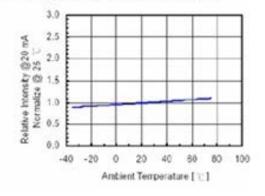


Fig 2. Relative Intensity vs. Forward Current









#### **Precautions For Use :**

#### **Over - current - proof**

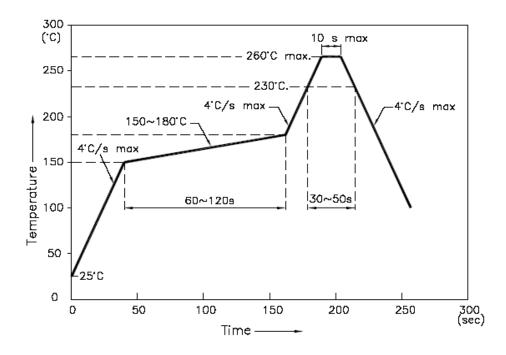
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen)

#### Storage

1. The operation of temperature and R.H. are :  $5^{\circ}$ C ~  $30^{\circ}$ C ,  $60^{\circ}$ R.H. Max.

- 2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a dampproof box with desiccating regent. Considering the tape life, we suggest our customers to use our products within 1.5 year (from production date).
- 3. It's recommended to bake before soldering when the package is unsealed after 72 hrs. The condition is :  $60^{\circ}C\pm 5^{\circ}C$  for 15 hrs.

■ Reflow Temp/Time





#### NOTES:

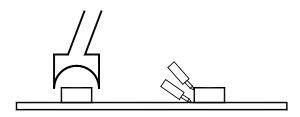
- 1. We recommend the reflow temperature  $245^{\circ}C(\pm 5^{\circ}C)$ .the maximum soldering temperature should be limited to  $260^{\circ}C$ .
- 2. dont cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

#### ■Soldering iron

Basic spec is  $\leq 5$  sec when 260°C. If temperature is higher, time should be shorter (+10°C  $\rightarrow$  -1sec ).Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 230°C.

#### Rework

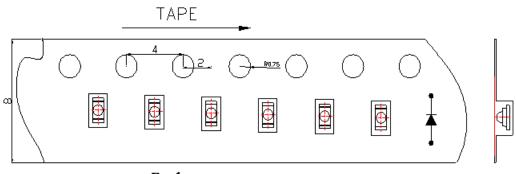
- 1. Customer must finish rework within 5 sec under  $260^{\circ}$ C.
- 2. The head of iron can not touch copper foil
- 3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow 、 solder etc.



### **Packaging specification**



Package: 3000 PCS/reel

